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| Previous Version: September 2007, Data Sheet, V2.2 | | | |
|--|--|--|--|
| Page | Subjects (major changes since last revision) | | |
| all | Changes due to PCN 2009-069-A | | |
| 5 | New Ordering Code inserted | | |
| 5 | Changes due to PCN PCN 2017-106 | | |

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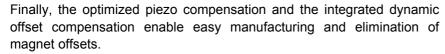
Differential Two-Wire Hall Effect Sensor IC

TLE4941C in PG-SSO-2-4

1 Product Description

1.1 Overview

The Hall Effect sensor IC TLE4941C is designed to provide information about rotational speed to modern vehicle dynamics control systems and ABS. The output has been designed as a two wire current interface. The sensor operates without external components and combines a fast power-up time with a low cut-off frequency. Excellent accuracy and sensitivity is specified for harsh automotive requirements as a wide temperature range, high ESD and EMC robustness. State-of-the art BiCMOS technology is used for monolithic integration of the active sensor areas and the signal conditioning circuitry.



The TLE4941C is additionally provided with an overmolded 1.8 nF capacitor for improved EMI performance.



- · Two-wire current interface
- Dynamic self-calibration principle
- · Single chip solution
- · No external components needed
- · High sensitivity
- · South and north pole pre-induction possible
- High resistance to piezo effects
- Large operating air-gaps
- · Wide operating temperature range
- TLE4941C: 1.8 nF overmolded capacitor



| Product Name | Product Type | Ordering Code | Package |
|------------------------|--------------------|---------------|------------|
| TLE4941C in PG-SSO-2-4 | Diff. Speed Sensor | SP001952924 | PG-SSO-2-4 |



Functional Description

2 Functional Description

2.1 General

The differential hall sensor IC detects the motion of ferromagnetic and permanent magnet structures by measuring the differential flux density of the magnetic field. To detect the motion of ferromagnetic objects the magnetic field must be provided by a back biasing permanent magnet. Either south or north pole of the magnet can be attached to the rear unmarked side of the IC package.

Magnetic offsets of up to \pm 20 mT and device offsets are cancelled by a self-calibration algorithm. Only a few transitions are necessary for self-calibration. After the initial calibration sequence switching occurs when the input signal is crossing the arithmetic mean of its max. and min. value (e.g. zero-crossing for sinusoidal signals).

The ON and OFF state of the IC are indicated by *High* and *Low* current consumption.

2.2 Pin Configuration and Marking

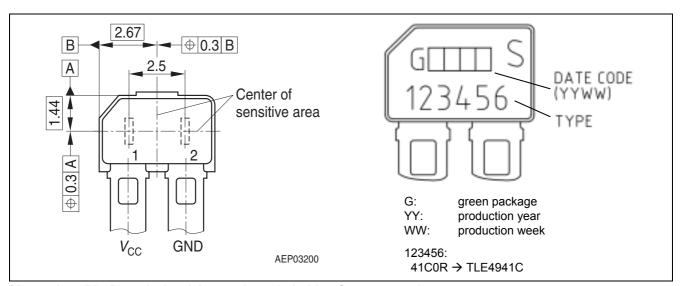


Figure 1 Pin Description (view on branded side of component)



Functional Description

2.3 Block Diagram

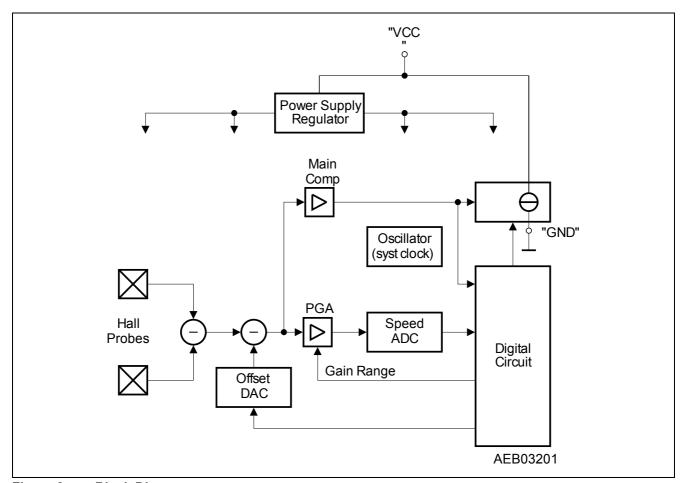


Figure 2 Block Diagram

The circuit is supplied internally by a 3 V voltage regulator. An on-chip oscillator serves as clock generator for the digital part of the circuit.

TLE4941C signal path is comprised of a pair of hall probes, spaced at 2.5 mm, a differential amplifier including a noise-limiting low-pass filter and a comparator feeding a switched current output stage. In addition an offset cancellation feedback loop is provided by a signal-tracking A/D converter, a digital signal processor (DSP) and an offset cancellation D/A converter.

During the startup phase (un-calibrated mode) the output is disabled ($I = I_{1 \text{ OW}}$).

The differential input signal is digitized in the speed A/D converter and fed into the DSP. The minimum and maximum values of the input signal are extracted and their corresponding arithmetic mean value is calculated. The offset of this mean value is determined and fed into the offset cancellation DAC.

After successful correction of the offset, the output switching is enabled.

In running mode (calibrated mode) the offset correction algorithm of the DSP is switched into a low-jitter mode, avoiding oscillation of the offset DAC LSB. Switching occurs at zero-crossing. It is only affected by the (small) remaining offset of the comparator and by the remaining propagation delay time of the signal path, mainly determined by the noise-limiting filter. Signals below a defined threshold ΔB_{Limit} are not detected to avoid unwanted parasitic switching.



Functional Description

2.3.1 Output Description

Under ideal conditions, the output shows a duty cycle of 50%. Under real conditions, the duty cycle is determined by the mechanical dimensions of the target wheel and its tolerances (40% to 60% might be exceeded for pitch >> 5 mm due to the zero-crossing principle).

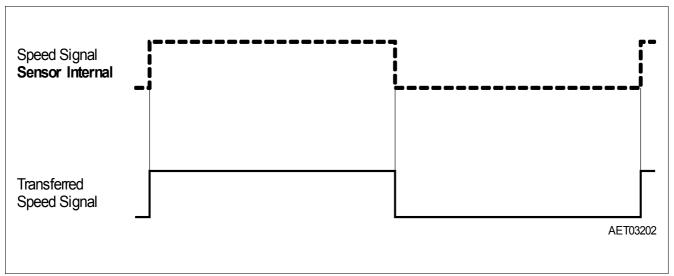


Figure 3 Speed Signal (half a period = $0.5 \times 1/f_{speed}$)

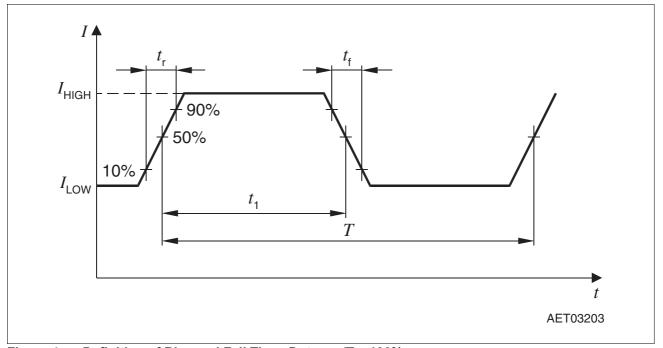


Figure 4 Definition of Rise and Fall Time, Duty = $t_1/T \times 100\%$



3 Specification

3.1 Absolute Maximum Ratings

Table 1 Absolute Maximum Ratings

 $T_{\rm j}$ = -40°C to 150°C, 4.5 V $\leq V_{\rm cc} \leq$ 16.5 V

| Parameter | Symbol | Limit Values | | Unit | Remarks |
|--------------------------|----------------|--------------|------|------|------------------------------------|
| | | min. | max. | | |
| Supply voltage | V_{CC} | - 0.3 | _ | V | <i>T</i> _j < 80°C |
| | | _ | 16.5 | | $T_{\rm j}$ = 170°C |
| | | _ | 20 | | $T_{\rm j}$ = 150°C |
| | | _ | 22 | | $t = 10 \times 5 \text{ min.}$ |
| | | _ | 24 | | $t = 10 \times 5 \text{ min.},$ |
| | | | | | $R_{M} \geq 75 \ \Omega$ |
| | | | | | included in $V_{\rm CC}$ |
| | | _ | 27 | | t = 400 ms, $R_{\rm M} \ge 75 Ω$ |
| | | | | | included in $V_{\rm CC}$ |
| Reverse polarity current | I_{rev} | _ | 200 | mA | External current limitation |
| | 767 | | | | required, |
| | | | | | t<4 h |
| Junction temperature | $T_{\rm j}$ | _ | 150 | °C | 5000 h, V _{CC} < 16.5 V |
| | | _ | 160 | | 2500 h, V _{CC} < 16.5 V |
| | | | | | (not additive) |
| | | _ | 170 | | 500 h, $V_{\rm CC}$ < 16.5 V |
| | | | | | (not additive) |
| | | _ | 190 | | 4 h, V _{CC} < 16.5 V |
| Active lifetime | $t_{B,active}$ | 10000 | - | h | |
| Storage temperature | T_{S} | - 40 | 150 | °C | |
| Thermal resistance | R_{thJA} | _ | 190 | K/W | 1) |
| PG-SSO-2-4 | | | | | |

¹⁾ Can be significantly improved by further processing like overmolding

Attention: Stresses above the max. values listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

Table 2 ESD Protection

Human Body Model (HBM) tests according to Standard EIA/JESD22-A114-B HBM (covers MIL STD 883D)

| Parameter | Symbol | Limit Values | | Unit | Notes |
|----------------|-----------|--------------|------|------|-------------------|
| | | min. | max. | | |
| ESD-Protection | V_{ESD} | | | kV | $R = 1.5 k\Omega$ |
| TLE4941C | | _ | ± 12 | | C = 100 pF |



3.2 Operating Range

Table 3 Operating Range

| Parameter | Symbol | Limit Values | | Unit | Remarks | |
|---|------------------------------|--------------|-------|------|---|--|
| | | min. max. | | | | |
| Supply voltage | V _{CC} | 4.5 | 20 | V | Directly on IC leads includes not the voltage drop at $R_{\rm M}$ | |
| Supply voltage ripple | V_{AC} | _ | 6 | Vpp | $V_{\rm CC}$ = 13 V 0 < f < 50 kHz | |
| Junction temperature | $T_{\rm j}$ | - 40 | 150 | °C | | |
| | | _ | 170 | | 500 h, $V_{\rm CC} \leq$ 16.5 V, increased jitter permissible | |
| Pre-induction | B_0 | - 500 | + 500 | mT | | |
| Pre-induction offset between outer probes | $\Delta B_{\rm stat.,\;l/r}$ | - 20 | + 20 | mT | | |
| Differential Induction | ΔB | - 120 | + 120 | mT | | |

Note: Within the operating range the functions given in the circuit description are fulfilled.



3.3 Electrical Characteristics

Table 4 Electrical Characteristics

All values specified at constant amplitude and offset of input signal, over operating range, unless otherwise specified. Typical values correspond to $V_{\rm CC}$ = 12 V and $T_{\rm A}$ = 25°C

| Parameter | Symbol | Limit Values | | | Unit | Remarks |
|--|--------------------------|----------------------|------|-----------------|------------------------------|---|
| | | min. | typ. | max. | | |
| Supply current | I_{LOW} | 5.9 | 7 | 8.4 | mA | |
| Supply current | I_{HIGH} | 11.8 | 14 | 16.8 | mA | |
| Supply current ratio | I_{HIGH} / I_{LOW} | 1.9 | _ | _ | | |
| Output rise/fall slew rate TLE4941C | $t_{\rm r},t_{\rm f}$ | 12 7.5 | | 26 24 | mA/μs | $R_{\rm M} \le 150~\Omega$ $R_{\rm M} \le 750~\Omega$ See Figure 4 |
| Output rise/fall slew rate TLE4941C | t_{r},t_{f} | 8 | _ | 22 26 | mA/μs | $R_{\rm M} = 75 \Omega$ $T < 125^{\circ}{\rm C}$ $T < 170^{\circ}{\rm C}$ See Figure 4 |
| Current ripple dI_X/dV_{CC} | I_{X} | _ | _ | 90 | μA/V | only valid for 4941 ¹⁾ |
| Limit threshold 1 Hz < f < 2500 Hz 2500 Hz < f < 10000 Hz | ΔB_{Limit} | 0.35 | 0.8 | 1.5 1.7 | mT | 2) |
| Initial calibration delay time | $t_{\sf d,input}$ | _ | _ | 300 | μs | Additional to $n_{\text{start}}^{3)}$ |
| Magnetic edges required for initial calibration | n _{start} | _ | 3 | 6 ⁴⁾ | magn. edges ⁵⁾ | 7 th edge correct ⁶⁾ |
| Frequency | f | 1 ⁷⁾ 2500 | | 2500 10000 | Hz | 8) |
| Frequency changes | df/dt | _ | _ | ± 100 | Hz/ms | |
| Duty cycle | duty | 40 | 50 | 60 | % | $^{9)}\Delta B$ = 2 mT sin-wave Def. See Figure 4 |
| Jitter, T_j < 150°C T_j < 170°C 1 Hz < f < 2500 Hz | $S_{ m Jit	ext{-close}}$ | | | ± 2 ± 3 | % | V_{CC} = 12 V ΔB ≥ 2 mT |
| Jitter, $T_j < 150$ °C $T_j < 170$ °C 2500 Hz < $f < 10000$ Hz | $S_{ m Jit	ext{-close}}$ | - | | ± 3 ± 4.5 | % | V_{CC} = 12 V ΔB ≥ 2 mT |
| Jitter, T_j < 150°C T_j < 170°C 1 Hz < f < 2500 Hz | $S_{ m Jit	ext{-}far}$ | - | - | ± 4 ± 6 | % | V_{CC} = 12 V 2 mT $\geq \Delta B > \Delta B_{\text{Limit}}$ |
| Jitter, T_j < 150°C T_j < 170°C 2500 Hz < f < 10000 Hz | $S_{Jit	ext{-far}}$ | | | ± 6 ± 9 | % | V_{CC} = 12 V 2 mT $\geq \Delta B > \Delta B_{\text{Limit}}$ |
| Jitter at board net ripple | $S_{Jit	ext{-AC}}$ | _ | _ | ± 2 | % | $V_{CC} = 13 V \pm 6 V_{pp}$ 0 < f < 50 kHz $\Delta B = 15 \text{ mT}$ |

¹⁾ only valid for TLE4941. For TLE4941C higher values occure and depend strongly on R_m-C combination

²⁾ Magnetic amplitude values, sine magnetic field, limits refer to the 50% critera. 50% of edges are missing



- 3) Occurrence of Initial Calibration Delay Time $t_{d,input}$
 - If there is no input signal (standstill), a new initial calibration is triggered each 0.7 s. This calibration has a duration $t_{\rm d,input}$ of max. 300 μ s. No input signal change is detected during that initial calibration time. In normal operation (signal startup) the probability of $t_{\rm d,input}$ to come into effect is: $t_{\rm d,input}$ / time frame for new calibration 300 μ s/700 ms = 0.05%. After IC resets (e.g. after a significant undervoltage) $t_{\rm d,input}$ will always come into effect.
- 4) Magnetic Input Signal Extremely Close to a Switching Threshold of PGA (Pragrammable Gain Amplifier) at Signal Startup After signal startup generally all PGA switching into the appropriate gain state happens within less than one signal period. This is included in the calculation for n_{DZ-Start}. For the very rare case that the signal amplitude is extremely close to a PGA switching threshold and the full range of following speed ADC respectively, a slight change of the signal amplitude can cause one further PGA switching. It can be caused by non-perfect magnetic signal (e.g. amplitude modulation due to tolerances of pole-wheel, tooth wheel or air gap variation). This additional PGA switching can result in a further delay of the output signal (n_{DZ-Start}) up to three magnetic edges leading to a worst case of n_{DZ-Start} = 9. Due to the low probability of this case it is not defined as max. value in the data sheet.
- 5) The sensor requieres up to n_{start} magnetic switching edges for valid speed information after power-up or after a stand still condition. During that phase the output is disabled.
- 6) One magnetic edge is defined as a montonic signal change of more than 3.3 mT
- 7) only valid in calibrated mode. For entering calibrated mode higher frequencies are necessary.
- 8) High frequency behavior not subject to production test verified by design/characterization. Frequency above 2500 Hz may have influence on jitter performance and magnetic thresholds
- 9) During fast offset alterations, due to the calibration algorithm, exceeding the specified duty cycle is permitted for short time periods
- 10) Not subject to production test verified by design/characterization



3.4 Typical Diagrams (measured performance)

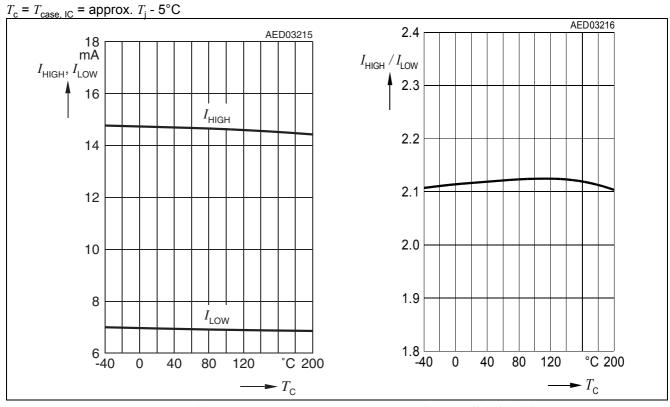


Figure 5 Supply Current = f(T) (left), Supply Current Ratio $I_{high}/I_{Low} = f(T)$ (right)

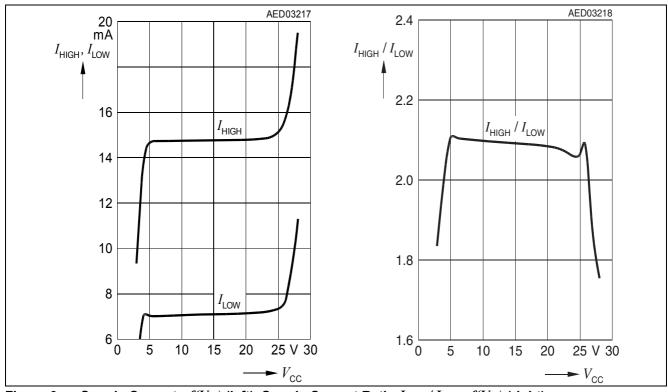
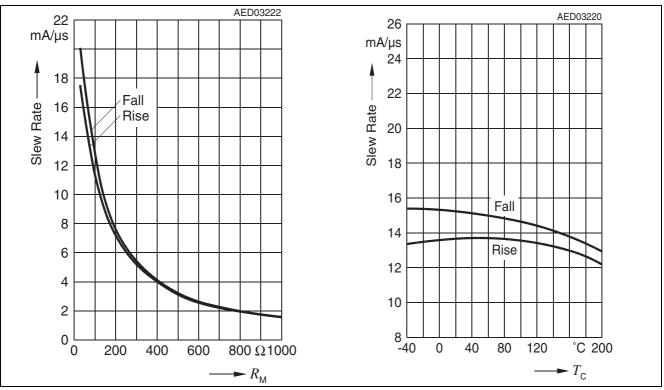


Figure 6 Supply Current = $f(V_{cc})$ (left), Supply Current Ratio I_{high}/I_{Low} = $f(V_{cc})$ (right)





Slew Rate with $C = 1.8 \text{ nF} = f(R_M)$ (left), Slew Rate with C = 1.8 nF, $R_M = 75 \Omega$ (right)

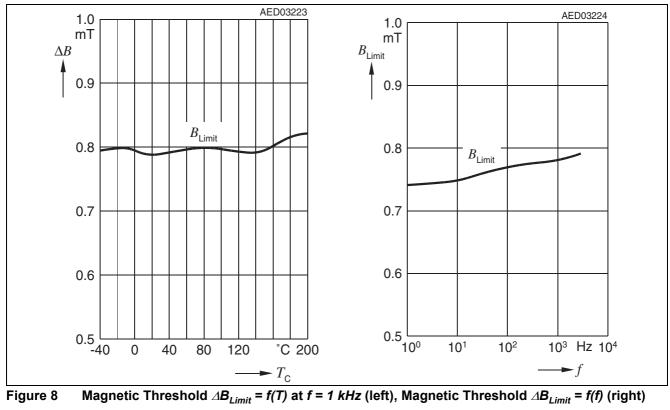


Figure 8



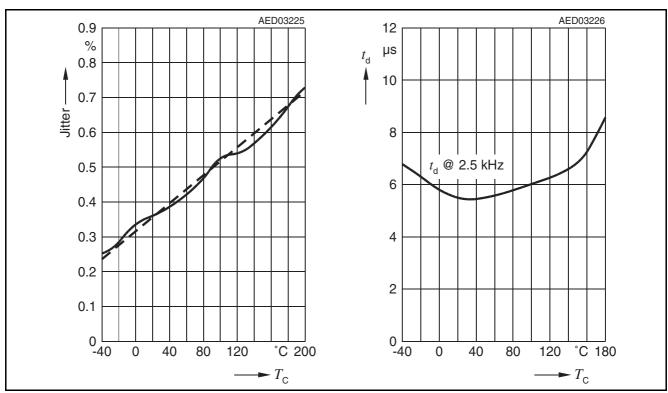


Figure 9 Jitter 1σ at $\Delta B = 2 mT$ at 1 kHz (left), Delaytime t_d (right) 1)

¹⁾ t_d is the time between the zero crossing of $\Delta B = 2$ mT sinusoidal input signal and the rising edge (50%) of the signal current.



3.5 Electro Magnetic Compatibility (EMC)

Table 5 Electro Magnetic Compatibility (values depend on $R_{\rm M}$!)

Ref. ISO 7637-1; test circuit 1;

 ΔB = 2 mT (amplitude of sinus signal); $V_{\rm CC}$ = 13.5 V, $f_{\rm B}$ = 100 Hz; T = 25°C; $R_{\rm M} \ge$ 75 Ω

| Parameter | Symbol | Level/Typ | Status | |
|--------------|-----------|---------------------------|-----------------|--|
| Testpulse 1 | V_{EMC} | IV / – 100 V | C ²⁾ | |
| Testpulse 2 | | IV / 100 V | C ²⁾ | |
| Testpulse 3a | | IV / - 150 V | Α | |
| Testpulse 3b | | IV / 100 V | Α | |
| Testpulse 4 | | IV / – 7 V | B ³⁾ | |
| Testpulse 5 | | IV / 86.5 V ¹⁾ | С | |

Note: Values are valid for all TLE4941C/42C types!

Ref. ISO 7637-3; test circuit 1;

 ΔB = 2 mT (amplitude of sinus signal); $V_{\rm CC}$ = 13.5 V, $f_{\rm B}$ = 100 Hz; T = 25°C; $R_{\rm M}$ \geq 75 Ω

| Parameter | Symbol | Level/Typ | Status |
|--------------|-----------|-------------|--------|
| Testpulse 1 | V_{EMC} | IV / – 30 V | A |
| Testpulse 2 | | IV / 30 V | A |
| Testpulse 3a | | IV / – 60 V | Α |
| Testpulse 3b | | IV / 40 V | Α |

Note: Values are valid for all TLE4941C/42C types!

Ref. ISO 11452-3; test circuit 1; measured in TEM-cell

 ΔB = 2 mT; $V_{\rm CC}$ = 13.5 V, $f_{\rm B}$ = 100 Hz; T = 25°C

| Parameter | Symbol | Level/Typ | Remarks |
|--------------------|-----------------------|--------------|--------------------|
| EMC field strength | E _{TEM-Cell} | IV / 250 V/m | AM = 80%,f = 1 kHz |

Note: Only valid for C-types!

- 1) Applying in the board net a suppressor diode with sufficient energy absorption capability
- 2) According to 7637-1 the supply switched "OFF" for t = 200 ms
- 3) According to 7637-1 for test pulse 4 the test voltage shall be 12 V \pm 0.2 V. Measured with $R_{\rm M}$ = 75 Ω only. Mainly the current consumption will decrease. Status C with test circuit 1



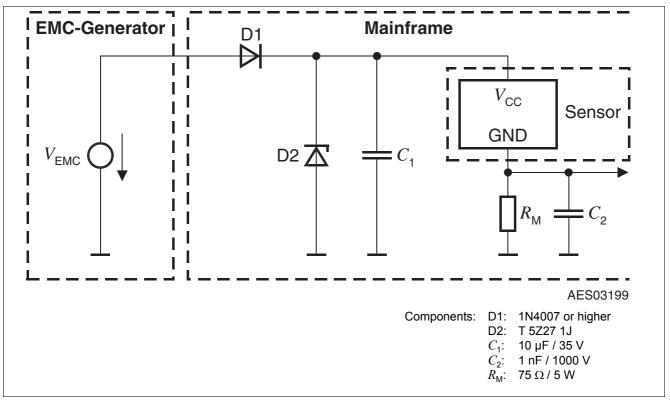


Figure 10 EMC Test Circuit 1



Package Information

4 Package Information

Pure tin covering (green lead plating) is used. Leadframe material is Wieland K62 (UNS: C18090) and contains CuSn1CrNiTi. Product is RoHS (restriction of hazardous substances) compliant when marked with letter G in front or after the data code marking and may contain a data matrix code on the rear side of the package (see also information note 136/03). Please refer to your Key account team or regional sales if you need further information.

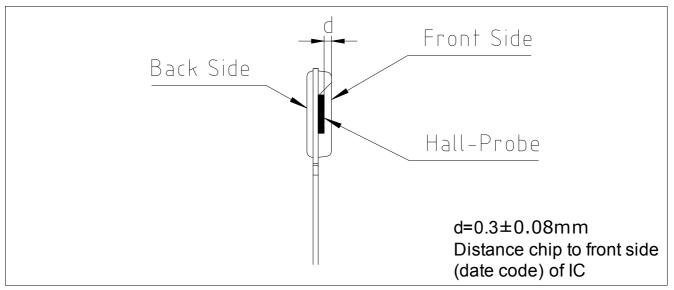


Figure 11 Distance Chip to Upper Side of IC

.



Package Information

4.1 Package Outline

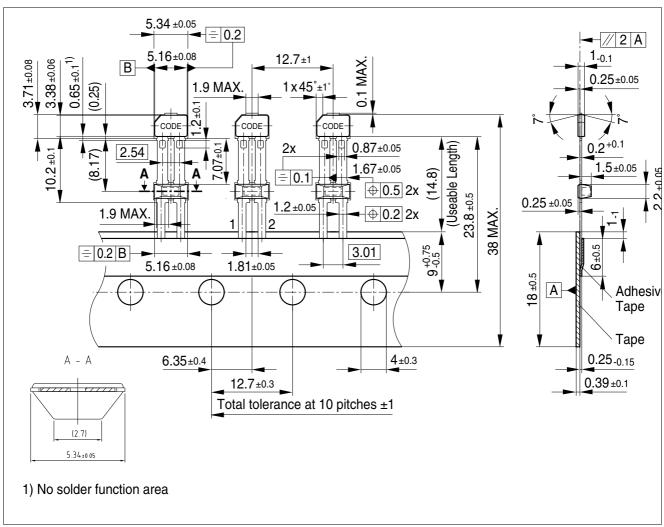


Figure 12 PG-SSO-2-4 (Plastic Single Small Outline Package); Dimensions in mm

4.2 Packing

You can find all of our packages, sorty of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products

Final Data Sheet

